

101408C FB750-.3 750 MHz Resonator 0.3 MHz Bandwidth

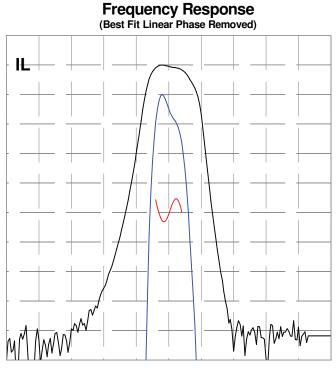
Specifications

Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	Fo		750		MHz
Bandwidth	В		0.3		MHz
–3 dB Bandwidth	B ₃	0.4	0.5		MHz
–40 dB Bandwidth	B ₄₀		1.2	1.3	MHz
Delay	To	2.2	2.376	2.56	µsec
Insertion Loss	IL		11.4	14.5	dB
Amplitude Ripple			0.8	2.2	dB _{P-P}
Phase Ripple			8.3	18	deg _{P-P}
Rejection		75	82		dB
Spurious for $ t - T_0 > .9T_0$					dB
Substrate Material	30YX-Q				

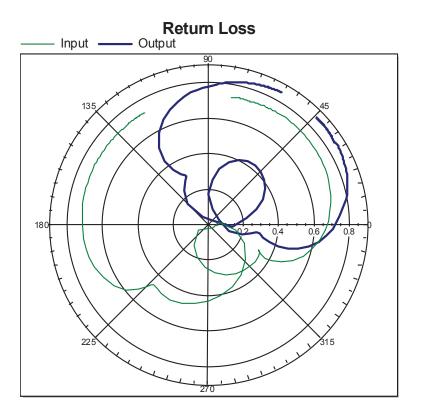
Notes

- 1. Center Frequency (F₀) and Bandwidth (B) are defined, not measured.
- 2. Insertion Loss is the minimum loss for $|f F_0| < .5B$
- 3. Ripple spec applies to the $|f F_0| < .4B$, and is doubled for $.4B < |f F_0| < .5B$
- 4. Rejection spec applies to $(B_{40} \text{ Spec} B/2) < |f F_0| < F_0/2$
- 5. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts dF₀ = $-x^*$ F₀, dT₀ = x^* T₀, where $x = 3E-8^*$ (temperature -22 °C)²

Typical Performance



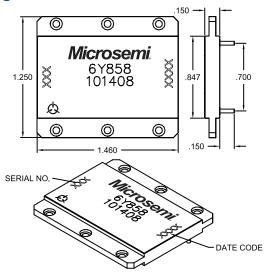
10 dB/div, 1 dB/div, 10 deg/div, 0.500 MHz/div



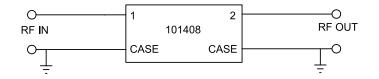


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Package Outline



Matching





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